NSN 5962-01-192-0217



Memory Microcircuit - Page 1 of 1 View Online at https://aerobasegroup.com/nsn/5962-01-192-0217 **Body Length:** Between 0.355 inches and 0.395 inches **Body Width:** Between 0.355 inches and 0.395 inches **Body Height:** 0.085 inches **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **Features Provided:** Monolithic and w/enable and hermetically sealed and burn in **Inclosure Material:** Ceramic **Inclosure Configuration:** Flat pack **Output Logic Form:** Complementary-metal oxide-semiconductor logic **Input Circuit Pattern:** 16 input **Terminal Surface Treatment:** Solder Voltage Rating And Type Per Characteristic: 8.3 volts power source **Time Rating Per Chacteristic:** 220.00 nanoseconds propagation delay time, low to high level output and 220.00 nanoseconds propagation delay time, high to low level output **Memory Device Type:** Rom **Test Data Document:** 96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.). **Terminal Type And Quantity:** 22 flat leads Shelf Life: N/a **Unit Of Measure: Demilitarization:**

Yes - demil/mli

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